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Inventor: SVEDBERG ET AL

Serial No. 10/736,611
Application Filing Date: 12/17/2003
Title: METHOD AND EXPANSION DEVICE FOR PREPARING **EXPANDED THERMOPLASTIC MICROSPHERES**

IN THE UNITE PATENT AND TRADEMARK OFFICE

In re application of

LARS-OLOF SVEDBERG ET AL

Serial No.

10/736,611

Group Art Unit 1711

Filed:

12/17/2003

For:

METHOD AND EXPANSION DEVICE FOR PREPARING EXPANDED THERMOPLASTIC

MICROSPHERES

LIST OF DOCUMENTS SUBMITTED BY APPLICANT WITH INFORMATION DISCLOSURE STATEMENT (Substitute Form PTO-1449)

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

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SUBSTITUTE FORM PTO-1449 Date of Submission: 05/24/2004

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Other Documents

(Including Author, Title, Date and Place of Publication, Pertinent Pages, Etc.)

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Examiner:

Date Considered

Examiner:

Initial if reference considered. Draw line through citation if not in conformance and not considered.

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